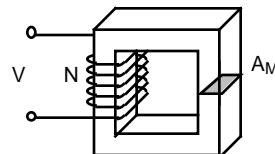
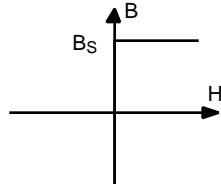


## Design Constraints

- **Saturation flux density**

- Sine-wave excitation
- Others similar
- Easily extended to multiple windings and inductors

$$N = \frac{\sqrt{2}V}{2 f A_M B_S}$$

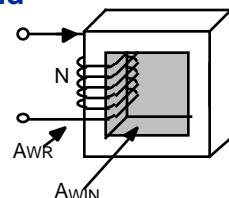


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## Design Constraints

- **Winding loss  $P_W$  - efficiency and temperature**

- $A_{WR}$  - wire cross-sectional area
- $F_W < 1$  - winding factor
- $I_{MT}$  - mean turn length
- $r$  - resistivity of wire
- $r_{WR}$  - winding resistance



$$A_{WR} = \frac{A_{WIN}}{N F_W}$$

$$r_{WR} = \frac{N I_{MT}}{A_{WR}} = \frac{N I_{MT}}{\frac{A_{WIN}}{N F_W}} = \frac{N^2 I_{MT} F_W}{A_{WIN}}$$



$$P_W = I^2 r_{WR} = I^2 \frac{N^2 I_{MT} F_W}{A_{WIN}} = I^2 \frac{\frac{\sqrt{2}V}{2 f A_M B_S}^2 I_{MT} F_W}{A_{WIN}}$$

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## Design Constraints

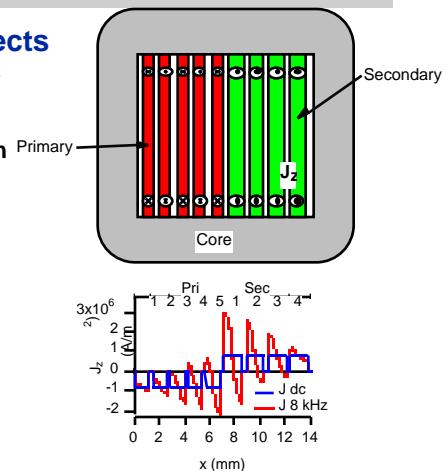
- **Core size**
  - Core magnetic cross-sectional area  $A_M$
  - Core window cross-sectional area  $A_{WIN}$
- **Material Properties**
  - Resistivity of winding
  - Saturation flux density of core  $B_s$
  - Core loss???
- **Frequency???**



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## Frequency Limitation

- **Eddy current effects**
  - Lossless magnetic material
  - Non-uniform current distribution
  - Dramatic increase in winding loss
- **Core loss in addition**



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## Magnetics Technology Assessment

### ● Magnetic materials

- crystalline alloys of Fe, Ni, Co and others
  - » lamination
  - » powdered
- ferrites
  - » Mn-Zn
  - » Ni-Zn
- amorphous alloys of Fe, Ni, Co and others

### ● Insulation

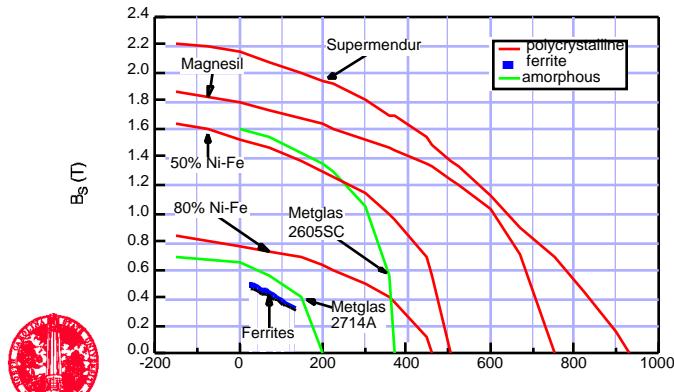
### ● Winding technology



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## Magnetics Technology

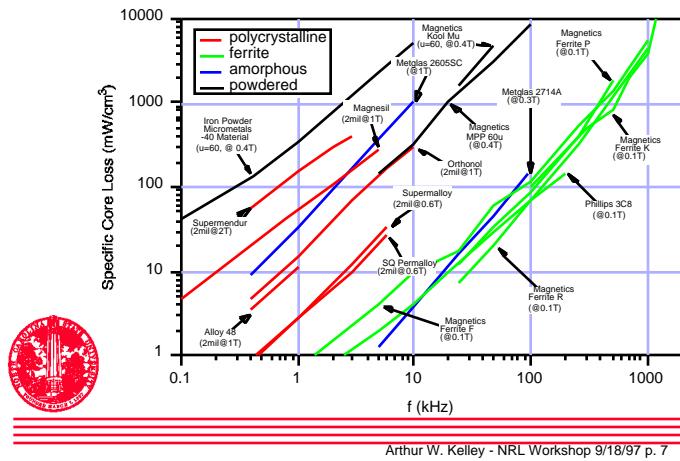
### ● Saturation flux density versus temperature



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## Magnetics Technology

### ● Specific core loss versus frequency



## Winding Insulation

### ● Requirements

- flexible and abrasion resistant
- thin
- high temperature

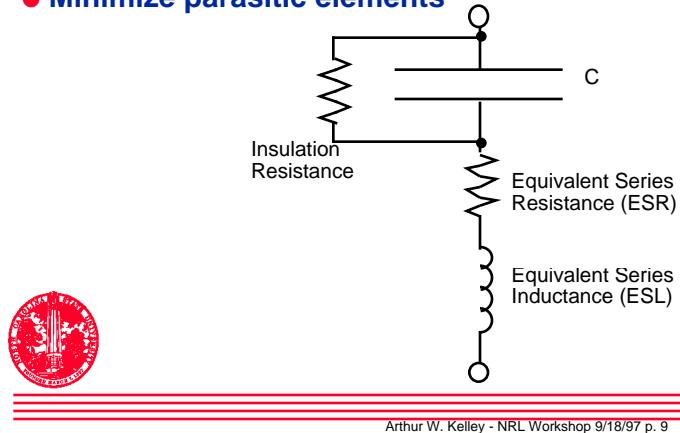
### ● Temperature Classes

- 105°C
  - » Polyvinyl acetal (Formvar), Polyvinyl formal, Acrylic, Polyurethane, Polyurethane
- 130°C
  - » Polyurethane nylon
- 155/180°C
  - » Polyester, Polyester nylon
- 180/200°C
  - » Polyester poly-amide-imide
- 220°C and 250°C
  - » Polyimide and High temp. Nylon (Nomex)

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## *Design Constraints*

- Minimum volume and weight
- Minimize parasitic elements



## *Capacitor Technology Assessment*

- Major capacitor technologies
  - aluminum electrolytic
  - polymer film
    - » “rolled”
    - » multilayer (MLP)
  - multilayer ceramic (MLC)
  - mica
  - glass K
- Standards - rare or nonexistent
  - physical
  - electrical



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## Capacitor Technology Assessment

- Capacitor performance

- voltage versus capacitance
- volume versus charge
- capacitance versus temperature
- dissipation factor versus frequency
- dissipation factor versus temperature
- ESR versus frequency
- insulation resistance versus temperature

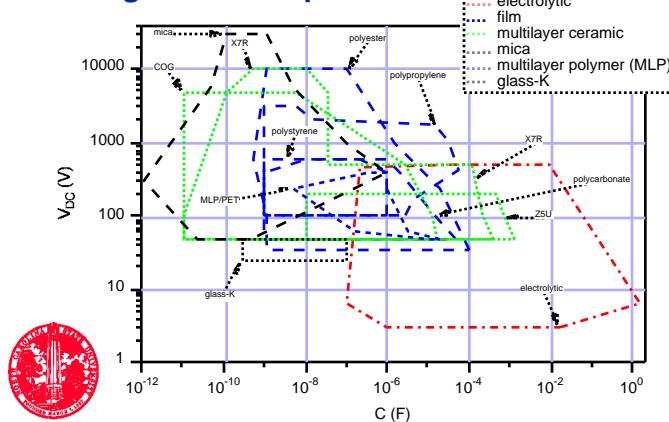
- No ideal capacitor



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## Capacitor Technology

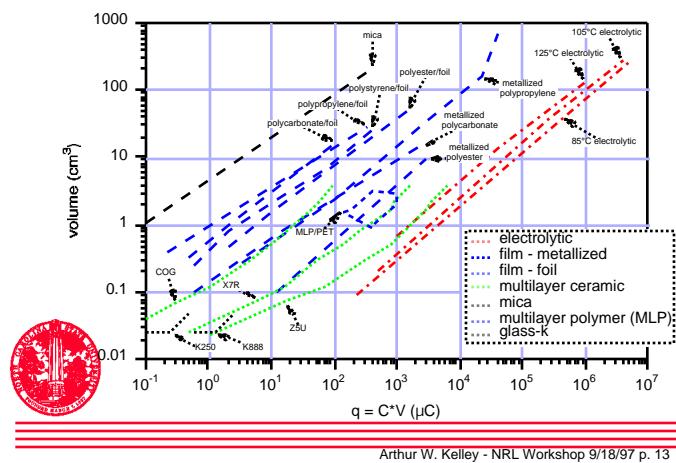
- Voltage versus capacitance



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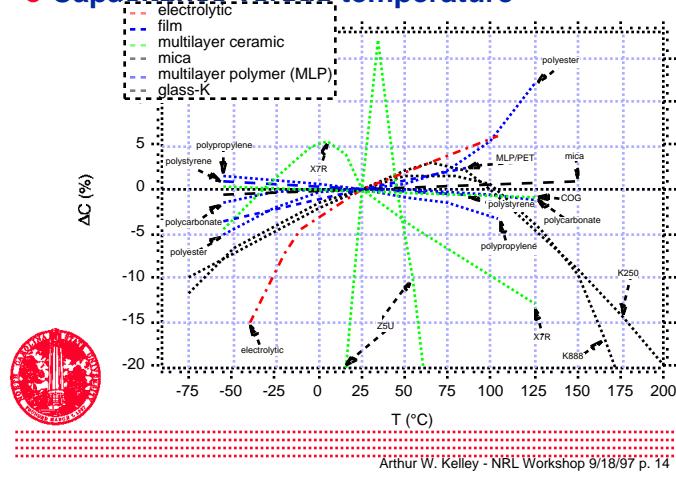
## Capacitor Technology

### ● Volume versus charge



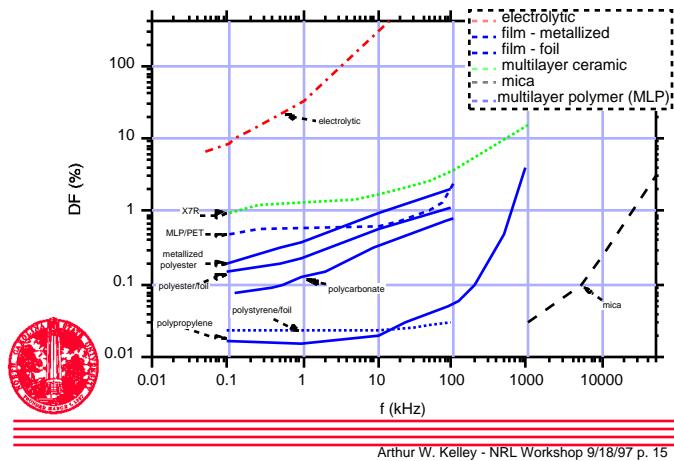
## Capacitor Technology

### ● Capacitance versus temperature



## Capacitor Technology

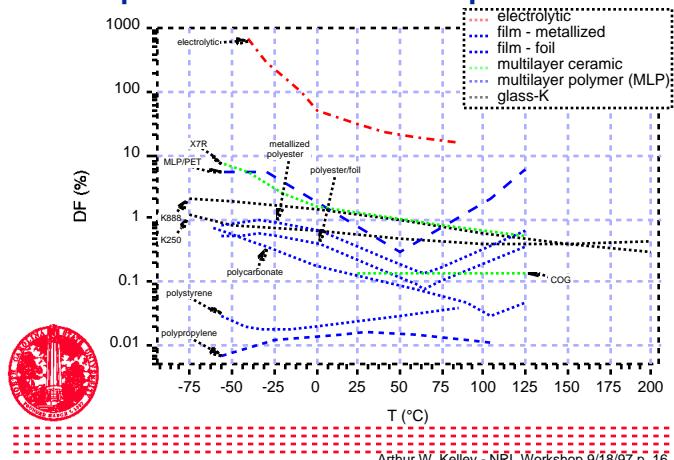
### ● Dissipation factor versus frequency



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## Capacitor Technology

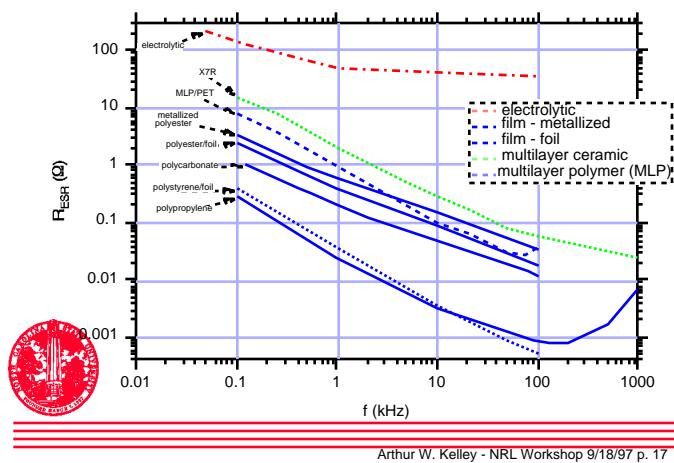
### ● Dissipation factor versus temperature



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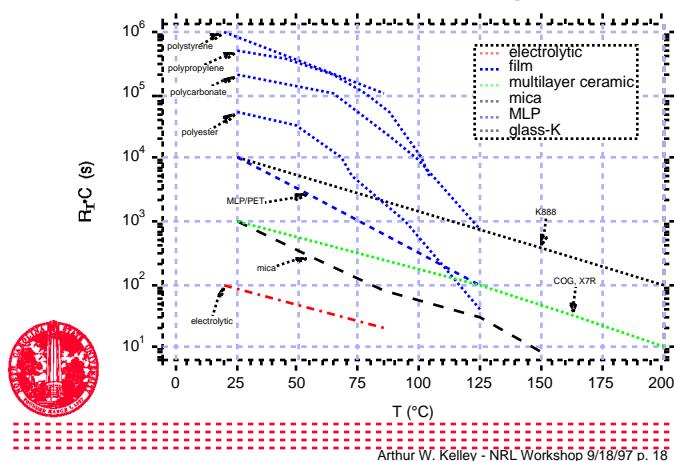
## Capacitor Technology

### ● ESR versus frequency



## Capacitor Technology

### ● Insulation resistance versus temperature



## ***Passive Component Challenges***

- Vertical integration rare
- Small market can't drive raw materials
- Lacking economic motivation
  - improved materials
  - better manufacturing
- Need high-temperature materials
  - polymers
  - magnetics materials
- Standards – hindered by competition
  - packaging
  - electrical specifications



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